

# thin film chip fuse





dimensions and construction



## ordering information

features

- Small, lightweight design
- Special manufacturing method stabilizing fusing characteristics and occupying less area
- Low power consumption and less voltage drop due to low internal resistance
- Suitable for overcurrent protection of circuit block in electronic devices
- · Suitable for flow and reflow soldering
- Products with lead-free terminations meet EU RoHS and China RoHS requirements

Туре	<b>Dimensions</b> inches ( <i>mm</i> )					
(Inch Size Code)	L	W	с	d	t	
TF10BN	.04±.004	.02±.002	.008±.004	.01±.004	.015±.002	
(0402)	(1.0±0.1)	(0.5±0.05)	(0.2±0.1)	(0.25±0.1)	(0.4±0.05)	
TF16AT	.063±.004	.031±.003	.012±.004	.012±.004	.018±.002	
(0603)	(1.6±0.1)	(0.8±0.08)	(0.3±0.1)	(0.3±0.1)	(0.45±0.05)	
TF16SN	.063±.008	.031±.004	.012±.004	.012±.004	$.015+ ^{+.004}_{002}$	
(0603)	(1.6±0.2)	(0.8±0.1)	(0.3±0.1)	(0.3±0.1)	$(0.4+ ^{+0.1}_{-0.05})$	



## applications and ratings

Part Designation	Marking	Rated Current	Fusing Time	Internal R. Maximum (mΩ)	Rated Voltage	Rated Ambient Temperature	Operating Temperature Range
TF10BN0.20	А	0.20A		1990	32V	+70°C	-55°C to +125°C
TF10BN0.25	С	0.25A		1270			
TF10BN0.315	D	0.315A		850			
TF10BN0.50	F	0.50A	Open within	320			
TF10BN0.63		0.63A	5 sec. at 200%	200			
TF10BN0.80	К	0.80A	rated current	135			
TF10BN1.00	L	1.00A	(Refer to Fusing	115			
TF10BN1.25	М	1.25A	Characteristics	90			
TF10BN1.60	N	1.60A	graph)	58			
TF10BN2.00	S	2.00A		42			
TF10BN2.50	Т	2.50A		35			
TF10BN3.00	V	3.00A		30			
TF16AT0.25	С	0.25A		498			
TF16AT0.315	D	0.315A		384	32V	+70°C	-55°C to +125°C
TF16AT0.50	F	0.50A	Open within	198			
TF16AT0.63		0.63A	5 sec. at 200%	143			
TF16AT0.80	K	0.80A	rated current (Refer to Fusing Characteristics graph)	120			
TF16AT1.00	L	1.00A		94			
TF16AT1.25	Μ	1.25A		73			
TF16AT1.60	N	1.60A		59			
TF16AT2.00	S	2.00A		42			
TF16AT2.50	Т	2.50A		32			
or further information on packaging, please refer to Appendix A.							

For further information on packaging, please refer to Appendix A.

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

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(TF16 only, 5,000 pieces/reel)





## thin film chip fuse

#### applications and ratings (continued)

				Internal R.		Rated	Operating
Part Designation	Marking	Rated Current	Fusing Time	Maximum (mΩ)	Rated Voltage	Ambient Temperature	Temperature Range
TF16AT3.15	U	3.15A	Open within 5 sec. at	24			-55°C
TF16AT4.00	Х	4.00A	200% rated current (Refer to Fusing	17	32V	+70°C	to
TF16AT5.00	Y	5.00A	Characteristics graph)	14			+125°C
TF16SN0.20	A	0.20A		1500			
TF16SN0.25	С	0.25A		960			
TF16SN0.315	D	0.315A		600	_		
TF16SN0.40	Н	0.40A	Open within	440			
TF16SN0.50	F	0.50A	1 sec. at 200%	300			
TF16SN0.63	I	0.63A	rated current	190			-40°C
TF16SN0.70	J	0.70A	(Refer to Fusing	170	32V	+70°C	to +125°C
TF16SN0.80	K	0.80A	Characteristics	135			
TF16SN1.00	L	1.00A	graph)	103			
TF16SN1.25	М	1.25A		78			
TF16SN1.60	N	1.60A		58			
TF16SN2.00	S	2.00A		47			
TF16SN2.50	Т	2.50A		38	]		
TF16SN3.15	U	3.15A		28			

# environmental applications

#### **Derating Curve**



Stationary Current: Regard the peak of stationary current waveform as stationary current value when the stationary current is repeated pulse.

Temperature Derating: Rated current needs to be

derated if used at an ambient temperature  $70^{\circ}$ C or above. Refer to the derating coefficient on the left figure.

Fusing Characteristics









#### **Performance Characteristics**

Fusing Current (A)

	Require	ement			
Parameter	Limit	Typical	Test Method		
Fusing Characteristics	Within 1 second (16SN) Within 5 seconds (10BN, 16AT)	_	200% of rated voltage shall be carried (@25°C)		
Bending Test	No mechanical damages	_	Distance between holding points: 90mm, Bending: 3mm, 1 time (BN, AT), 2mm, 1 time (SN)		
Resistance to Solder Heat	±10%	±4.5% (16SN) ±5% (10BN, 16AT)	$260^{\circ}C \pm 5^{\circ}C$ , 10 seconds $\pm 0.5^{4}$ second		
Solderability	95% coverage minimum		$245^{\circ}C \pm 3^{\circ}C$ , 3 seconds $\pm 0.5$ second		
Load Life	±10%	±4.5%(16SN) ±5% (10BN, 16AT)	$70^{\circ}C \pm 2^{\circ}C$ , 1000 hours, rated current x 100%, 1.5 hr ON, 0.5 hr OFF cycle		
Load Life Moisture	±10%	±3% (10BN) ±4.5% (16SN), 5% (16AT)	40°C ± 2°C, 90 - 95% RH, 1000 hours, rated current x 100% (10BN, 16SN), x 75% (16AT), 1.5 hr ON, 0.5 hr OFF cycle		
Rapid Change of Temperature	±10%	±4% (16SN) ±5% (10BN, 16AT)	16SN: -40°C ± 2°C (30 minutes), 10BN, 16AT: -55°C ± 2°C, +125°C (30 minutes), 10 cycles		
Resistance to Solvent	No evidence of damages to protective coating and marking		Conforming to MIL-STD-202F		
Residual Resistance	$10k\Omega$ and more	_	Measure DC resistance after fusing		
Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use. 12/19/17					

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